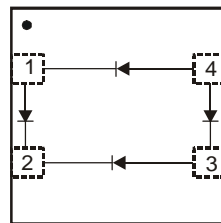


## Features

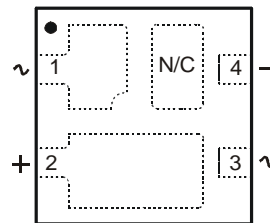
- Ultra Low Leakage Current
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **“Green” Device (Note 3)**

## Mechanical Data

- Case: DFN3030-4
- Case Material: Molded Plastic “Green” Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – NiPdAu Over Copper Lead Frame, Solderable per MIL-STD-202, Method 208 **e3**
- Polarity: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.02 grams (approximate)



Top View  
Device Schematic



Top View  
Pin Configuration

## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	60	V
Working Peak Reverse Voltage	V <sub>RWM</sub>		
DC Blocking Voltage	V <sub>RM</sub>		
Average Rectified Output Current	I <sub>O</sub>	500	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load (Per Diode)	I <sub>FSM</sub>	8	A

## Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Ambient Air (Note 2)	R <sub>θJA</sub>	215	-	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150		°C

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage (Per Diode)	V <sub>F</sub>	-	- 0.43 0.40	0.42 0.49 0.46	V	I <sub>F</sub> = 0.25A, T <sub>J</sub> = 25°C I <sub>F</sub> = 0.5A, T <sub>J</sub> = 25°C I <sub>F</sub> = 0.5A, T <sub>J</sub> = 125°C
Reverse Current (Note 4) (Per Diode)	I <sub>R</sub>	-	17 2.8	100 20	μA mA	V <sub>R</sub> = 60V, T <sub>J</sub> = 25°C V <sub>R</sub> = 60V, T <sub>J</sub> = 125°C

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
  2. Polyimide PCB, 2 oz. copper; minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
  3. Diodes Inc.'s “Green” policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php)
  4. Short duration pulse test used to minimize self-heating effect.

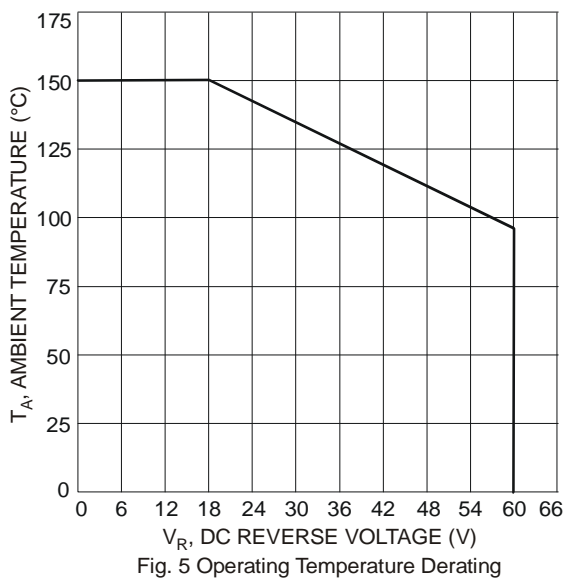
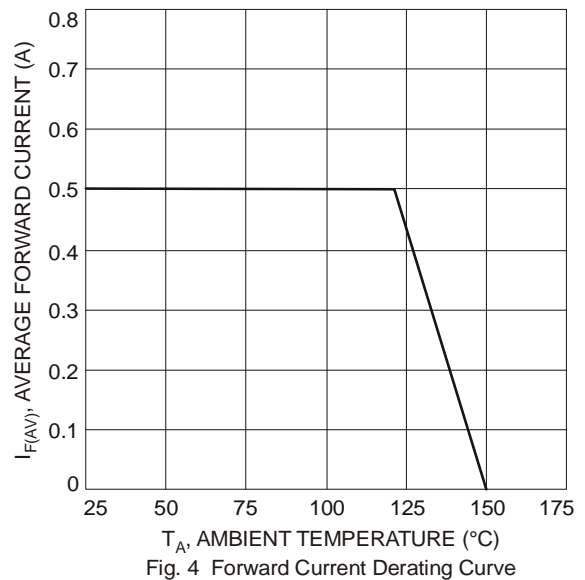
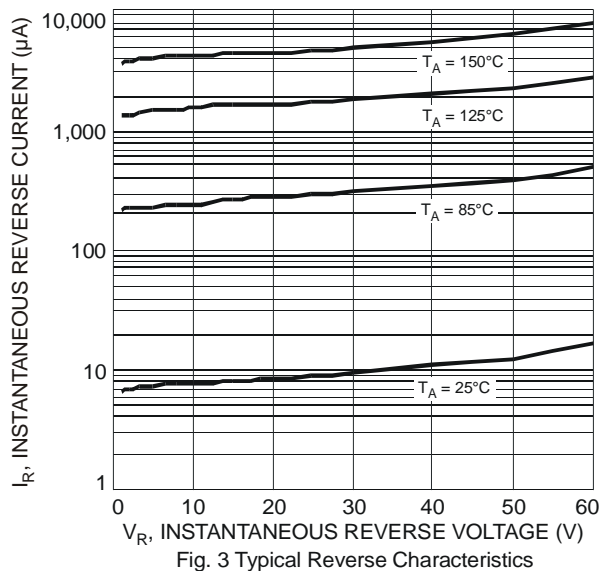
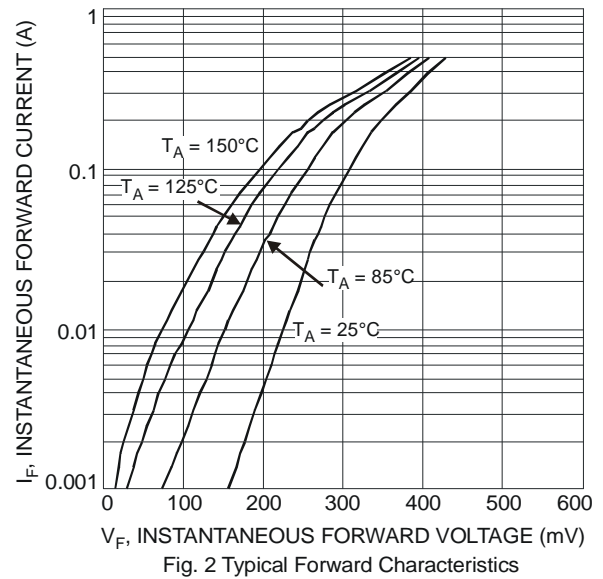
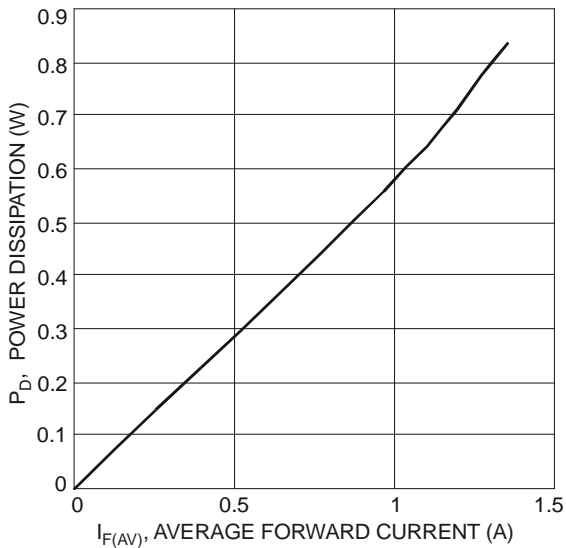
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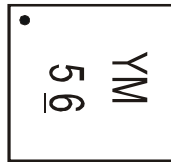
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## Ordering Information (Note 5)

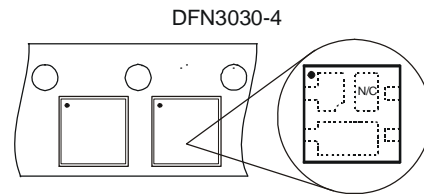
Part Number	Case	Packaging
SBR05M60BLP-7	DFN3030-4	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

## Marking Information



56 = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: W = 2009)  
 M = Month (ex: 9 = September)



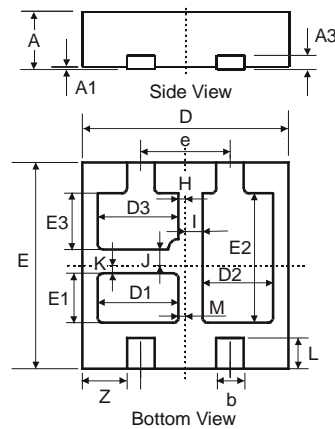
### Date Code Key

Year	2009	2010	2011	2012	2013	2014	2015
Code	W	X	Y	Z	A	B	C

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

## Package Outline Dimensions



DFN3030-4			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0	0.05	0.02
A3	-	-	0.15
b	0.35	0.45	0.40
D	2.90	3.10	3.00
D1	1.075	1.275	1.175
D2	0.925	1.125	1.025
D3	1.075	1.275	1.175
E	2.90	3.10	3.00
e	-	-	1.30
E1	0.615	0.815	0.715
E2	1.78	1.98	1.88
E3	0.715	0.915	0.815
H	0.05	0.15	0.10
I	0.20	0.30	0.25
J	0.185	0.285	0.235
K	0.065	0.165	0.115
L	0.30	0.60	0.45
M	0.05	0.15	0.10
Z	-	-	0.65
All Dimensions in mm			

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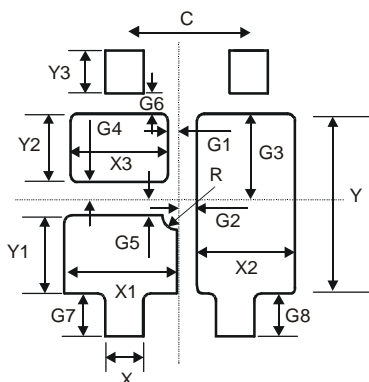
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## Suggested Pad Layout



Dimensions	Value (in mm)
C	1.300
G1	0.100
G2	0.150
G3	0.830
G4	0.115
G5	0.135
G6	0.170
G7	0.500
G8	0.500
R	0.150
X	0.500
X1	1.375
X2	1.225
X3	1.175
Y	1.980
Y1	1.015
Y2	0.715
Y3	0.650

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